

PRODUCT DATASHEET Iris series

last update 16/5/2012



Product number	CN10861_IRIS		
Family Type LED Color Diameter Height Style	Iris Pack Ostar Lighting Black 38 mm 28.5 mm Round	FWHM Efficiency cd/Im Gerber File Shipped as un separately.	11 degrees 90 % (simulated) 0.000 Available assembled - lens and holder
Optic Material Holder Material Fastening Status	PMMA PC Glue On production		
Product number	CN10953_IRIS-M		
Family Type LED Color Diameter Height Style Optic Material Holder Material Fastening Status Product number	Iris Pack Ostar Lighting Black 38 mm 30 mm Round PMMA PC Glue On production CN11470_IRIS-O	FWHM Efficiency cd/Im Gerber File	30 degrees - - Available
Family Type LED Color Diameter Height Style Optic Material Holder Material Fastening Status	Iris Pack Ostar Lighting Black 38 mm 30 mm Round PMMA PC Glue On production	FWHM Efficiency cd/Im Gerber File Suitable for Star P	40+30 degrees - - Available CB

NOTE: The typical divergence will be changed by different color, chip size and chip position tolerance. The typical total divergence is the full angle measured where the luminous intensity is half of the peak value.

Ledil Oy Salorankatu 10 24240 SALO Finland



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GENERAL INFORMATION

- Product series especially designed & optimized for Ostar Lighting series of LEDs.

- Special care taken to make light distribution as uniform as possible.

- Lens material optical grade PMMA with high UV and temperature resistance. Allows use of high current and temperature conditions.

Please find more information about used material from below:

http://ledil.fi/sites/default/files/Documents/Technical/Material/PMMA%208N%20UL94_Yellow%20Card.pdf http://ledil.fi/sites/default/files/Documents/Technical/Material/PMMA%208N%20PLEXIGLAS-Datasheet.pdf - Optic holder molded by high quality PC material (120 dergees of Celcius / 248 degrees of Fahrenheit).

- Fastening to PCB with appropriate adhesive. By clicking link below you can find Ledil recommended glue options.

http://www.ledil.com/datasheets/DataSheet_GLUES.pdf

NOTE 1: We advise customer to ensure the suitability and sufficiency of the bond in the end product. For example, mechanical stress, vibration and holes on the surface of the circuit boar weaken the strength of the glue.

NOTE 2: All surfaces where glue is applied must be clean, dry and free from grease and dirt. If cleaning of PCB surfaces is needed, please follow strictly the cleaning instructions of your LED manufacturer -this is important as cleaning shall under no circumstances damage LEDs or other electronics components on the PCB.

Further note that optical components shall not be cleaned with any chemicals - only micro fiber cloth may be used to remove fingerprints or other traces from handling.

